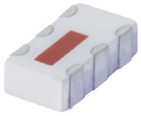
ULTRA-SMALL CERAMIC

Power Splitter/Combiner QCN-8AT+

2 Way-90° 50Ω 450 to 750 MHz

FEATURES

- Low insertion loss, 0.6 dB typ.
- Wrap-around terminal for excellent solderability
- Ultra small, 0.12"X0.06"X0.035"
- AEC-Q200 qualified component family



Generic photo used for illustration purposes only

CASE STYLE: FV1206-1

+RoHS Compliant
The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

APPLICATIONS

- Automotive

ELECTRICAL SPECIFICATIONS[1] AT +25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Frequency Range		450		750	MHz
Insertion Loss, above 3.0 dB	450-750 470-700		0.6 0.5	0.9 0.8	dB
Isolation	450-750 470-700	13 13	16 16		dB
Phase Unbalance	450-750 470-700		5 5	8 8	Degree
Amplitude Unbalance	450-750 470-700		0.5 0.3	1.0 0.8	dB
VSWR	450-750 470-700		1.4 1.4		(:1)

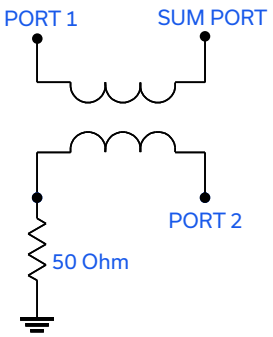
1. Tested on TB-255+ using QCN-8+ with evaluation board losses de-embedded.
2. For applications requiring DC voltage to be applied to the RF ports, add suffix letter "D" to part no. DC resistance to ground is 100 Mohms min.

ABSOLUTE MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-40°C to +105°C
Storage Temperature	-40°C to +105°C
Power Input (as a splitter)*	15 W max. at +25°C

* Derate linearly to 7 W at +105°C ambient.
Permanent damage may occur if any of these limits are exceeded.

ELECTRICAL SCHEMATIC



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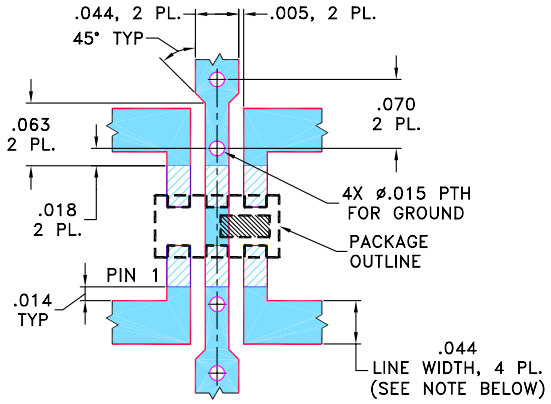
PIN CONNECTIONS

SUM PORT	1
PORT 1 (0°)	4
PORT 2 (+90°)	6
GROUND	2,5
50 OHM TERM EXTERNAL	3

PRODUCT MARKING: N/A

DEMO BOARD MCL P/N: TB-QCN-3+

SUGGESTED PCB LAYOUT (PL-131)

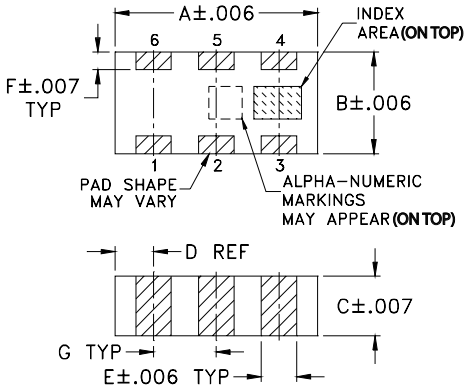


NOTES: 1.TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS 0.020" ± 0.0015"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2.BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

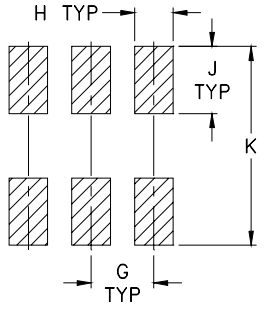
DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

OUTLINE DRAWING



PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

OUTLINE DIMENSIONS (Inches / mm)

A	B	C	D	E	F
.126	.063	.035	.024	.022	.011
3.20	1.60	0.89	0.61	0.56	0.28

G	H	J	K		wt
.039	.024	.042	.123		grams
0.99	0.61	1.07	3.12		.020

TAPE & REEL INFORMATION: F75

ULTRA-SMALL CERAMIC

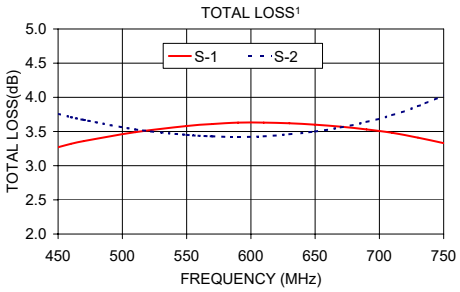
Power Splitter/Combiner QCN-8AT+

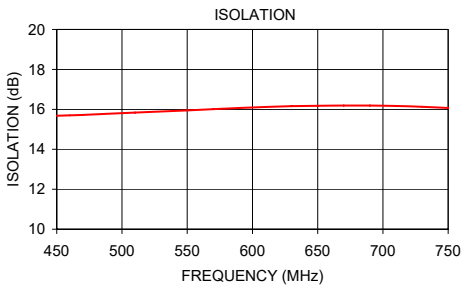
2 Way-90° 50Ω 450 to 750 MHz

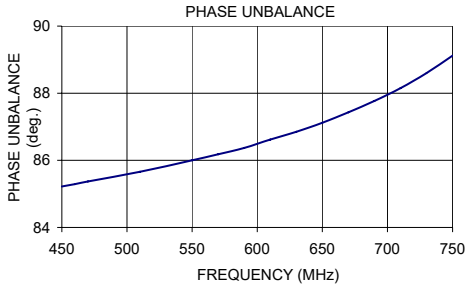
TYPICAL PERFORMANCE DATA

Frequency (MHz)	Total Loss[1] (dB)		Amplitude Unbalance (dB)	Isolation (dB)	Phase Unbalance (deg.)	VSWR (:1)		
	S-1	S-2				S	1	2
450	3.27	3.76	0.49	15.68	85.22	1.41	1.41	1.38
460	3.32	3.71	0.40	15.70	85.29	1.40	1.41	1.38
470	3.36	3.67	0.31	15.72	85.37	1.40	1.41	1.37
510	3.49	3.53	0.04	15.84	85.66	1.39	1.40	1.36
550	3.58	3.45	0.13	15.95	86.00	1.37	1.40	1.36
570	3.61	3.43	0.18	16.01	86.18	1.37	1.40	1.36
590	3.63	3.42	0.20	16.07	86.37	1.36	1.40	1.36
610	3.63	3.43	0.20	16.12	86.62	1.36	1.40	1.36
630	3.62	3.46	0.17	16.16	86.85	1.36	1.40	1.37
650	3.60	3.50	0.11	16.18	87.12	1.36	1.41	1.38
670	3.57	3.56	0.01	16.19	87.43	1.37	1.41	1.39
690	3.53	3.64	0.11	16.19	87.77	1.37	1.43	1.40
710	3.48	3.74	0.27	16.17	88.15	1.38	1.44	1.42
730	3.41	3.87	0.46	16.13	88.60	1.40	1.46	1.45
750	3.33	4.03	0.70	16.07	89.12	1.41	1.48	1.48

1. Total Loss = Insertion Loss + 3 dB splitter loss.







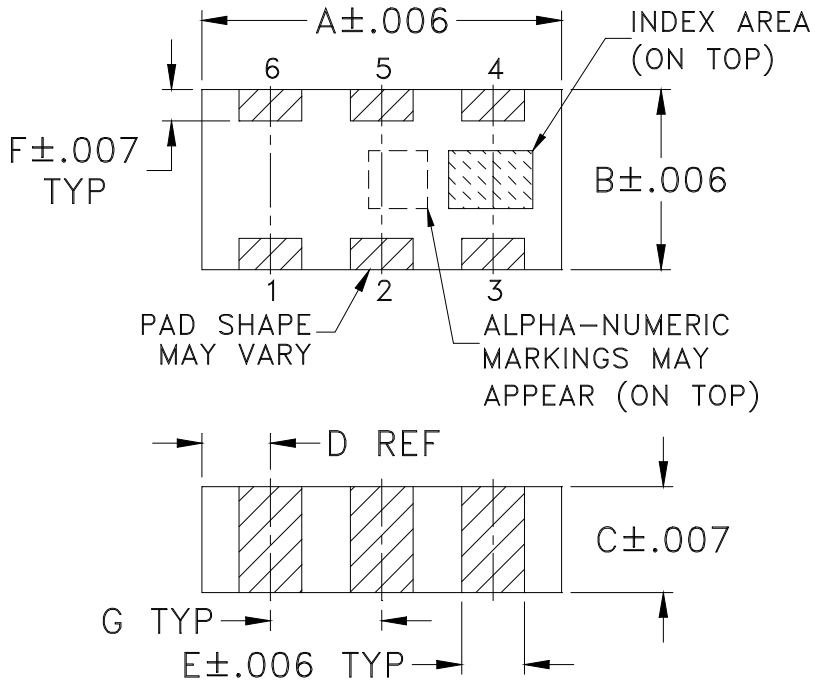
NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

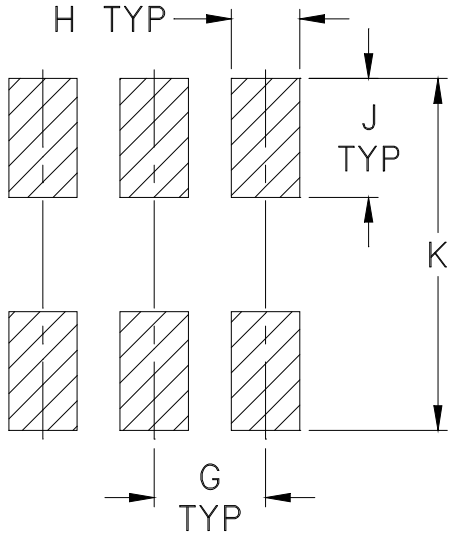
Case Style FV

FV1206-1

Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

CASE #	A	B	C	D	E	F	G	H	J	K	L	M	N	P	WT. GRAM
FV1206-1	.126 (3.20)	.063 (1.60)	.035 (0.89)	.024 (0.61)	.022 (0.56)	.011 (0.28)	.039 (0.99)	.024 (0.61)	.042 (1.07)	.123 (3.12)	-- --	-- --	-- --	-- --	.020

Dimensions are in inches (mm). Tolerances: 2 Pl. ± .01; 3 Pl. ± .005

Notes:

1. Open style, ceramic base.
2. Termination finish: **as shown below or indicated on Data Sheet.**
   For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
   For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.

Tape & Reel Packaging TR-F75

DEVICE ORIENTATION IN T&R

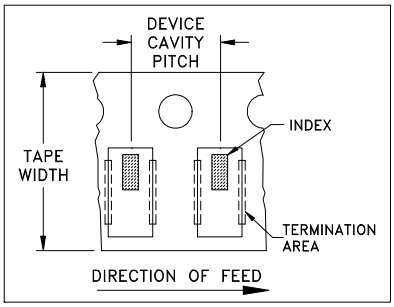


ILLUSTRATION 1

Applicable Case Styles
FV1206-1
FV1206-3

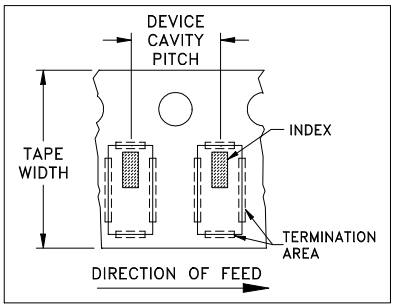


ILLUSTRATION 2

Applicable Case Styles
FV1206-4
FV1206-5
FV1206-6
FV1206-7
FV1206-9

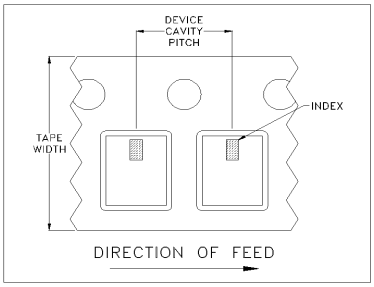


ILLUSTRATION 3

Applicable Case Styles
FV1206-11
FV1206-12
GE0805C-18
NL1008C-6
NL1008C-7
NL1008C-9
NL1008C-10
NL1008C-12

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	3000

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

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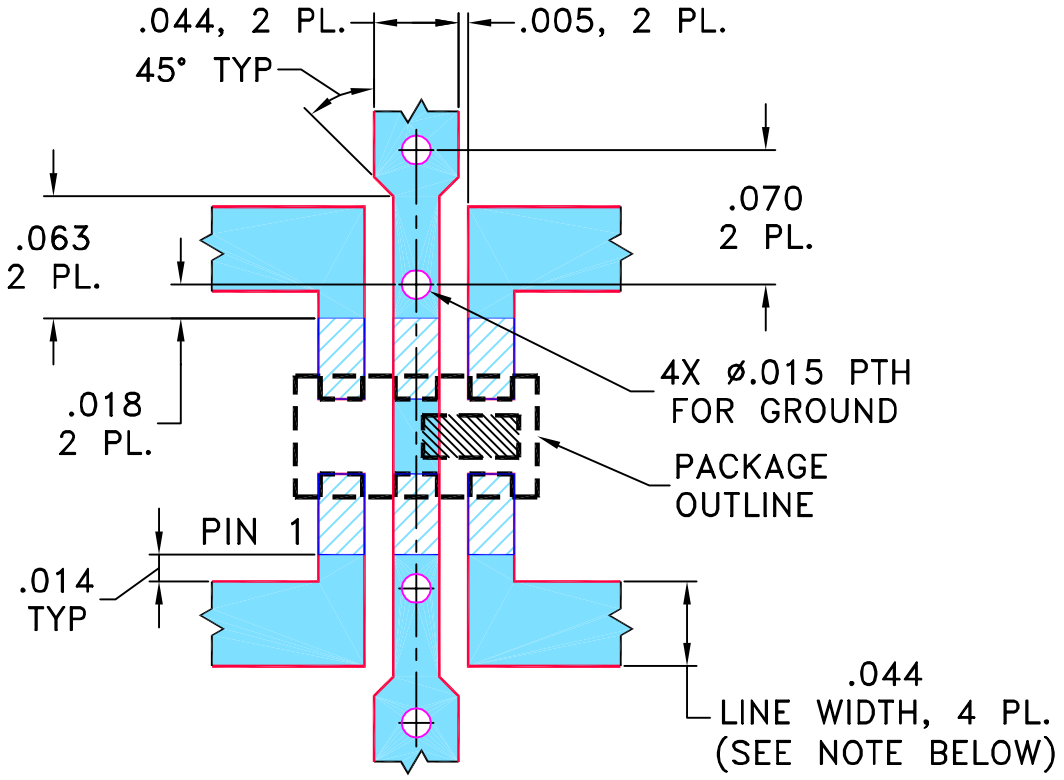
THIRD ANGLE PROJECTION

REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M87001	NEW RELEASE	05/20/03	MMG	ABD
A	M87231	CORRECTED DWG.	05/28/03	MMG	ABD
B	M91636	ADDED "pn" PIN CONNECTION	04/07/04	AV	ABD
C	M102713	ADDED"...WITH SMOBC"	01/16/06	GF	IL

SUGGESTED MOUNTING CONFIGURATION
FOR FV1206-1 CASE STYLE, "pb/pn" PIN CONNECTIONS



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2.BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	MMG	05/14/03
TOLERANCES ON:	CHECKED	AV	05/19/03
2 PL DECIMALS ±	APPROVED	ABD	05/20/03
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

ASHEETA1.DWG REV:A DATE:01/12/95

Mini-Circuits®
13 Neptune Avenue
Brooklyn NY 11235

PL, pb/pn, FV1206-1, QCN/BDCN, TB-255

SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-131	C

FILE:	SCALE:	SHEET:
98PL131	10:1	1 OF 1